

Dual Enhancement Mode MOSFET (N- and P-Channel)
● DESCRIPTION

The VIC1642DN-F is the highest performance trench N-Ch and P-Ch MOSFETs With extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

This device is suitable for use as a load switch or in PWM applications.

● FEATURE

Channel	BVDSS	RDSON(VGS=10V)	ID
N-Ch	40V	14mΩ (TYP.)	22A
p-Ch	-40V	25mΩ (TYP.)	-21A

● APPLICATIONS

- ◆ Motor Control
- ◆ For Fan Pre-driver H-Bridge
- ◆ Load/power switch

● PIN CONFIGURATION

● ABSOLUTE MAXIMUM RATINGS(TA=25°C Unless otherwise noted)

Symbol	Parameter	Rating		Unit
		N-Ch	P-Ch	
VDSS	Drain-Source Voltage	40	-40	V
VGSS	Gate-Source Voltage	±20	±20	
ID	Continuous Drain Current ,(VGS=10V)	22	-21	A
IDP	Drain Current (Pulse)	60	-48	A
TJ	Maximum Junction Temperature	-55 to 150		°C
TSTG	Storage Temperature Range	-55 to 150		
PD	Maximum Power Dissipation (Ta=25°C)	35	35	W

**● ELECTRICAL CHARACTERISTICS(TA=25°C Unless otherwise noted)**

Symbol	Parameter	Test Conditions	N-CH			Unit
			Min.	Typ.	Max.	
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	40	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =32V, V _{GS} =0V	--	--	1	μA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1	1.5	2.5	V
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
R _{DSON} a	Drain-Source On-state Resistance	V _{GS} =10V, I _D =15A	--	14	18	mΩ
		V _{GS} =4.5V, I _D =8A	--	18	23	
g _{fS}	Forward Transconductance a	V _{DS} =5V, I _D =15A	--	35	--	S
Dynamic b						
Q _G	Total Gate Charge	V _{GS} =4.5V, V _{DS} =32V, I _D =15A	--	11	15	nC
Q _{GS}	Gate-Source Charge		--	2.65	3.7	
Q _{GD}	Gate-Drain Charge		--	4.9	6.8	
C _{ISS}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz	--	1023	1428	pF
C _{OSS}	Output Capacitance		--	108	152	
C _{RSS}	Reverse Transfer Capacitance		--	78	108	
SWITCHING CHARACTERISTICS						
t _{d(ON)}	Turn-on Delay Time	V _{DD} =20V, V _{GS} =10V, I _{DS} =15A, R _G =3.3Ω	--	2.9	5.8	ns
t _{d(OFF)}	Turn-off Delay Time		--	21.4	43	
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
I _S	Drain-Source Diode Forward Current	V _G =V _D =0V, Force Current	--	--	15	A
V _{SD} a	Diode Forward Voltage	I _S = 1A, V _{GS} = 0V	--	--	1.2	V

● ELECTRICAL CHARACTERISTICS(TA=25°C Unless otherwise noted)

Symbol	Parameter	Test Conditions	P-CH			Unit
			Min.	Typ.	Max.	
Static Characteristics						
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-40	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-32V, V _{GS} =0V	--	--	-1	uA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1.2	-1.5	-2.5	V
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
R _{DS(ON) a}	Drain-Source On-state Resistance	V _{GS} =-10V, I _D =-8A	--	25	32	mΩ
		V _{GS} =-4.5V, I _D =-4A	--	38	46	
gfs	Forward Transconductance a	V _{DS} =5V, I _D =-8A	--	11	--	S
Dynamic b						
Q _g	Total Gate Charge	V _{GS} =-4.5V, V _{DS} =-15V, I _D =-1A	--	12	--	nC
Q _{gs}	Gate-Source Charge		--	3.5	--	
Q _{gd}	Gate-Drain Charge		--	3.3	--	
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-15V, f=1MHz	--	1415	--	pF
C _{oss}	Output Capacitance		--	134	--	
C _{rss}	Reverse Transfer Capacitance		--	102	--	
SWITCHING CHARACTERISTICS						
t _{d(ON)}	Turn-on Delay Time	V _{DD} =-15V, V _{GS} =-10V, I _D =-1A, R _G =3.3Ω	--	22	--	ns
t _{d(OFF)}	Turn-off Delay Time		--	59	--	
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
I _s	Continuous Source Current	V _g =V _d =0V, Force Current	--	--	-15	A
V _{sd a}	Diode Forward Voltage	I _s = -1A, V _{GS} = 0V	--	--	-1.2	V

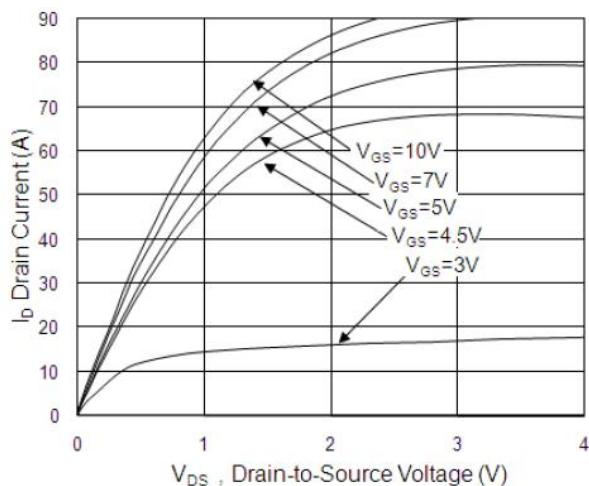
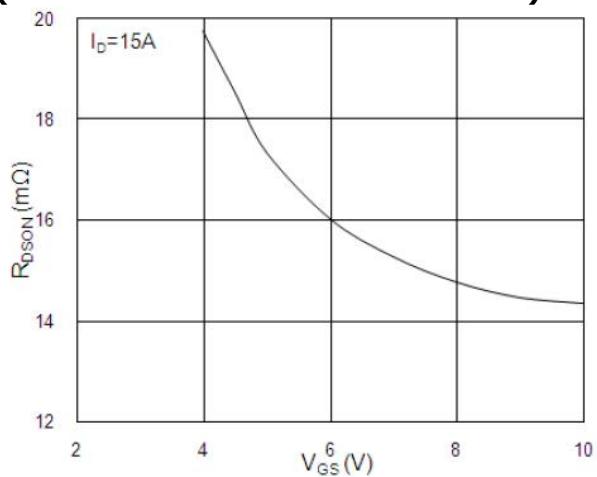
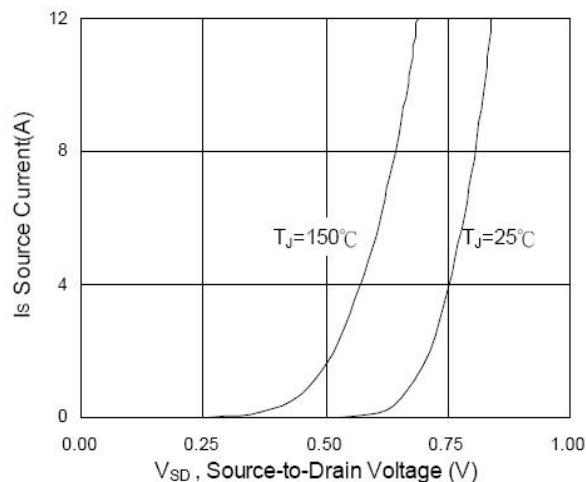
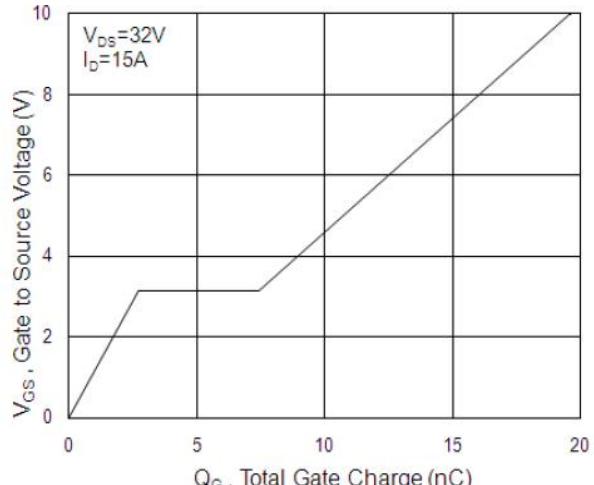
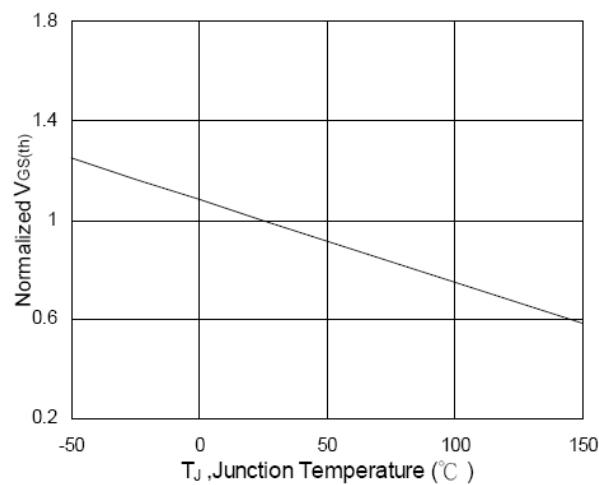
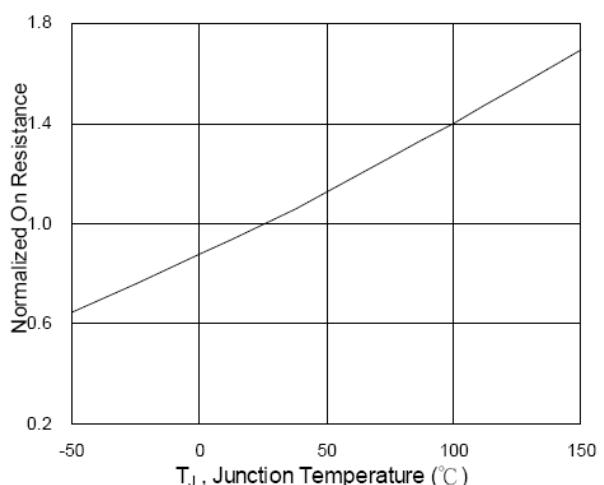
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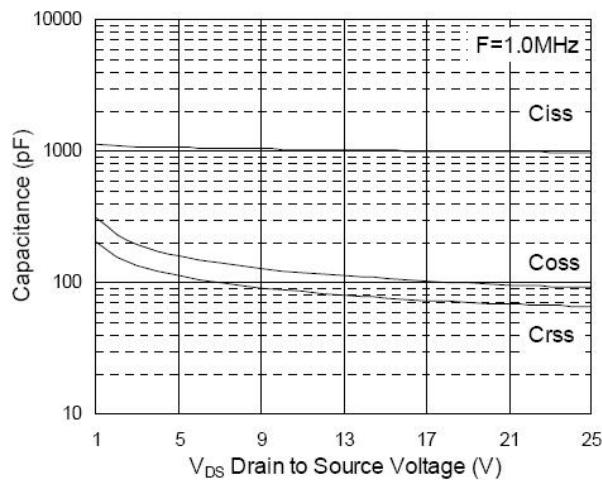
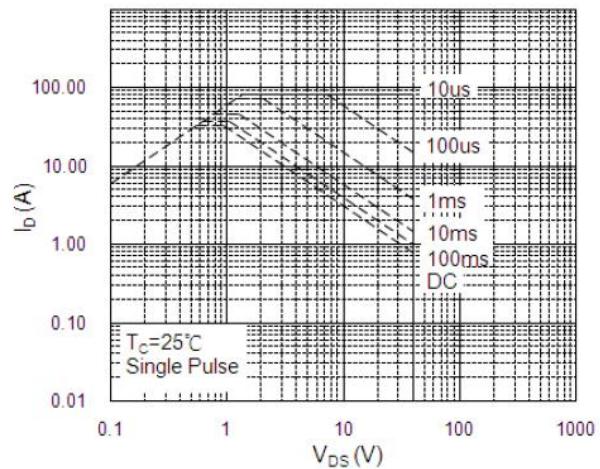
- a. Pulse test; pulse width ≤ 300us, duty cycle ≤ 2%.
- b. Guaranteed by design, not subject to production testing.

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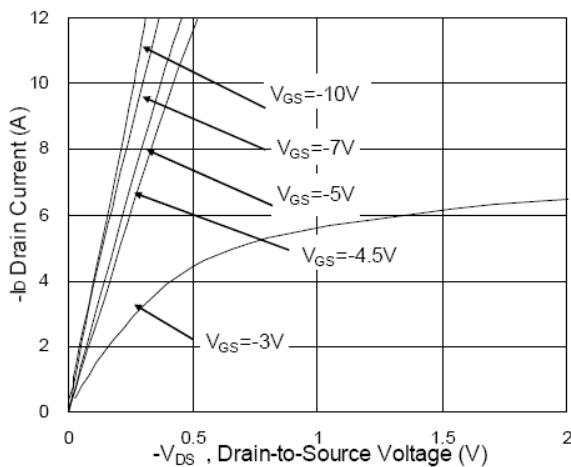
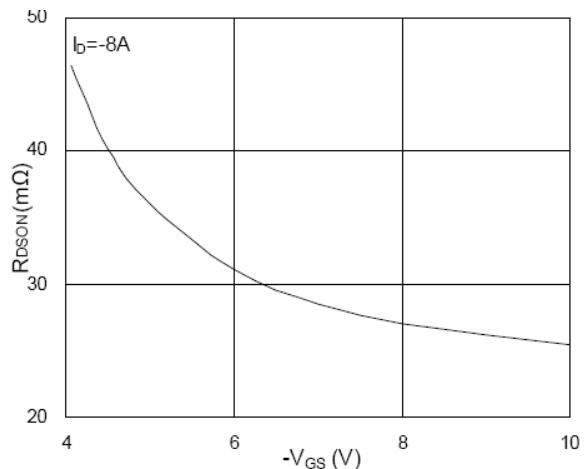
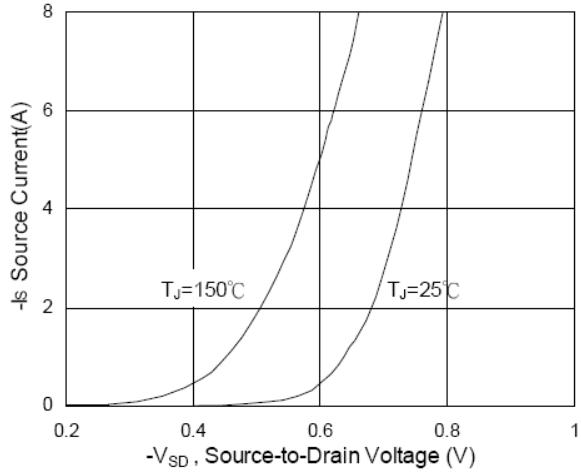
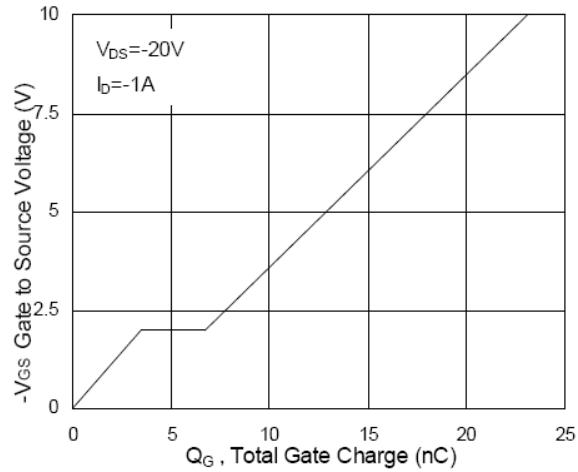
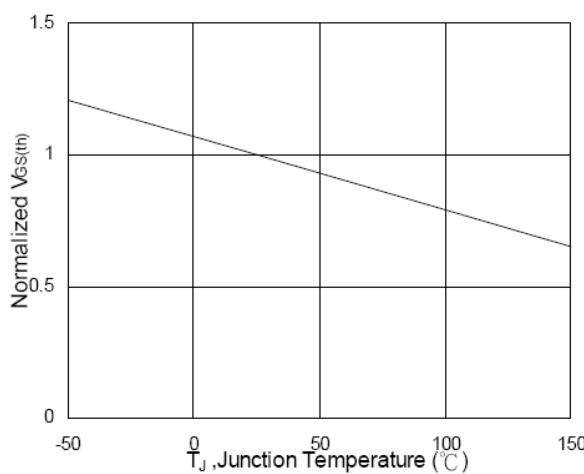
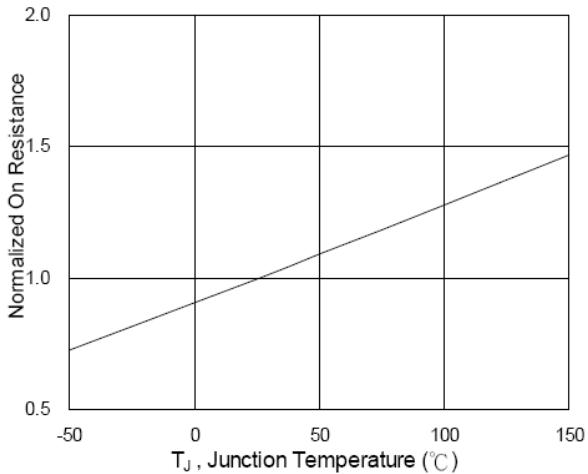
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● N-CH TYPICAL CHARACTERISTICS (TA=25°C Unless otherwise noted)

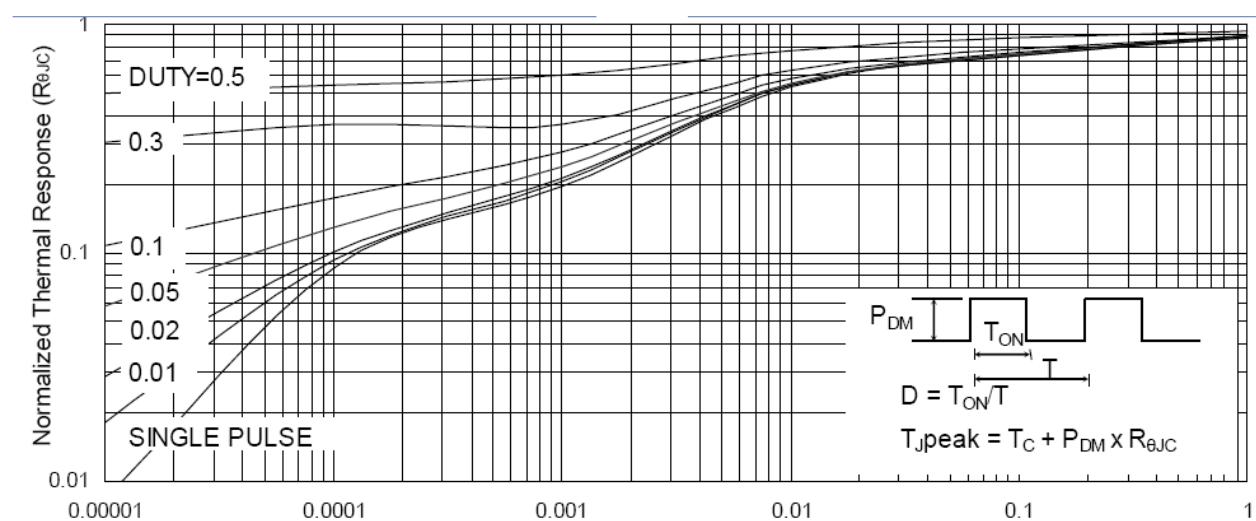
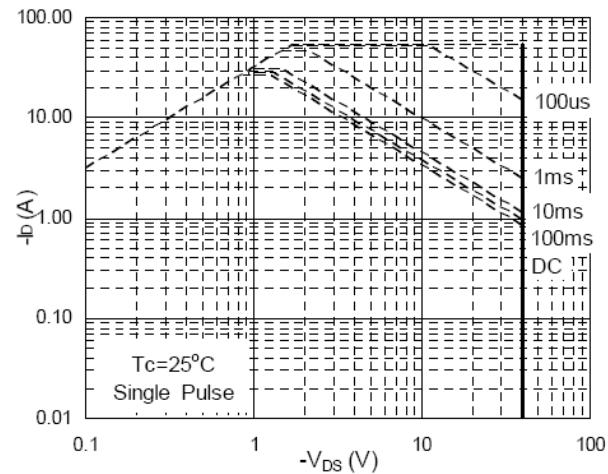
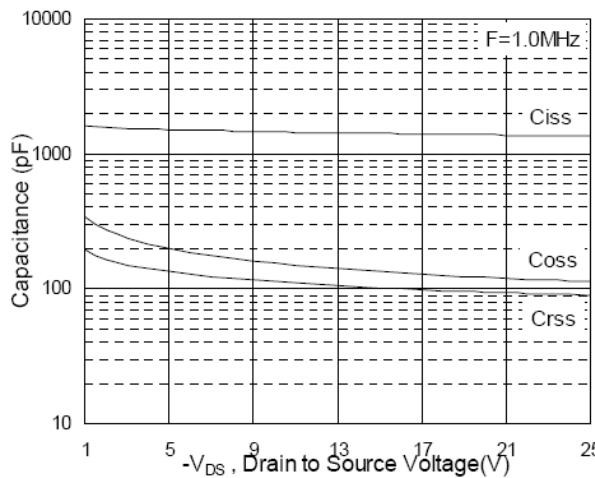

Fig.1 Typical Output Characteristics

Fig.2 On-Resistance v.s Gate-Source

Fig.3 Forward Characteristics of Reverse

Fig.4 Gate-Charge Characteristics

Fig.5 Normalized $V_{GS(th)}$ v.s T_j

Fig.6 Normalized $R_{DS(on)}$ v.s T_j

● N-CH TYPICAL CHARACTERISTICS (TA=25°C Unless otherwise noted)**Fig.7 Capacitance****Fig.8 Safe Operating Area**

● P-CH TYPICAL CHARACTERISTICS (TA=25°C Unless otherwise noted)


Fig.1 Typical Output Characteristics

Fig.2 On-Resistance v.s Gate-Source

Fig.3 Forward Characteristics of Reverse

Fig.4 Gate Charge Characteristics

Fig.5 Normalized $V_{GS(th)}$ v.s T_J

Fig.6 Normalized $R_{DS(on)}$ v.s T_J

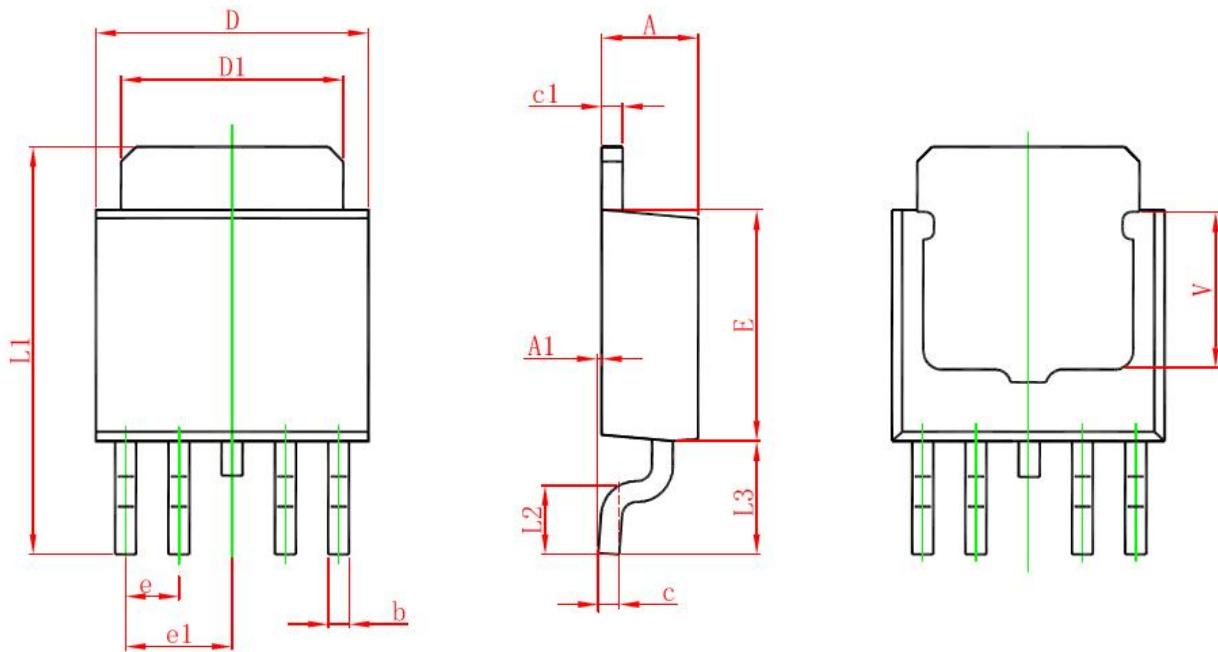
● P-CH TYPICAL CHARACTERISTICS (TA=25°C Unless otherwise noted)



● ORDERING INFORMATION

Part Number	Package code	Shipping
VIC1642DN-F	DN-F: TO252-4	2500/Tape & Reel

● PACKAGE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.400	0.600	0.016	0.024
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	1.270 TYP		0.050 TYP	
e1	2.540 TYP		1.000 TYP	
L1	9.500	9.900	0.374	0.390
L2	1.400	1.780	0.055	0.070
L3	2.550	2.900	0.100	0.114
V	3.45 REF		0.136 REF	



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